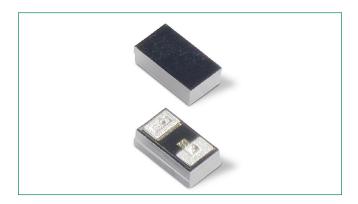


SP3145 Series 0.35pF 20kV Unidirectional Discrete TVS

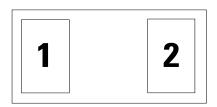




Description

The SP3145 represents an industry first: unidirectional ESD protection in a 01005 type package. Unidirectional protection should be favored over bi directional performance, particularly on logic and data lines, which typically do not transit zero volts during standard operation. Fast-acting, semiconductor based technology can withstand multiple ESD events, without wear-out or degradation. Low nominal capacitance makes this product meaningful for interfaces running at high data rates, approaching 5 GHz clock speeds.

Pinout



Note: Drawing not to scale

Features

- ESD, IEC 61000-4-2, ±20kV contact, ±25kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 2nd edition, 1A (tP=8/20µs)
- Low capacitance of 0.35pF (@VR=0V)
- Low leakage current of 20nA (MAX) at 2.8V
- Industry-first unidirectional protection, critical for data line protection, and any interface which does not transit zero volts
- Industry's smallest single channel form factor, nominally 01005
- Halogen free, Lead free and RoHS compliant

Functional Block Diagram



Applications

- Mobile Phones
- Smart Phones
- Camcorders
- Portable Medical
- Digital Cameras
- Wearable Technology
- Portable Navigation Components
- Tablets
- Point of Sale Terminals

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I _{pp}	Peak Current (t _p =8/20µs)	1.0 ¹	А
T _{OP}	Operating Temperature	-40 to 125	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

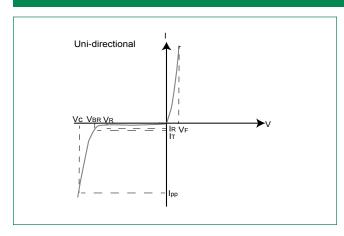
Electrical Characteristics (T_{OP}=25°C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
Reverse Standoff Voltage	V _{RWM}	-	-	-	3.3	V	
Breakdown Voltage	V _{BR}	I _R =1mA	-	7.5	-	V	
Forward Voltage	V _F	I _T =1mA	0.5	0.7	1.0	V	
Leakage Current ¹	I _{LEAK}	V _R =1.5V with 1 pin at GND	-	<1	5	nA	
		V _R =2.8V with 1 pin at GND	-	2.0	20		
Clamp Voltage ¹	V _c	I _{pp} =1A, t _p =8/20μs, Fwd	-	11.5	-	V	
Dynamic Resistance ²	R _{DYN}	TLP, t _p =100ns, I/O to GND	-	3.5	-	Ω	
ESD Withstand Voltage ¹	V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±20	-	-	kV	
		IEC 61000-4-2 (Air Discharge)	±25	-	-	kV	
Diode Capacitance ¹	C _D	Reverse Bias=0V	-	0.35	-	pF	

Note:

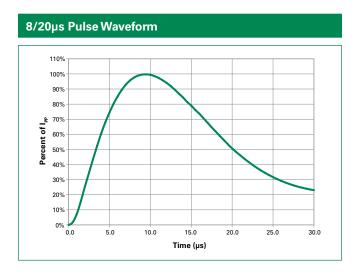
- Parameter is guaranteed by design and/or component characterization.
- 2. Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window t1=70ns to t2= 90ns

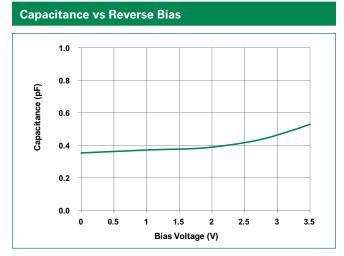
I-V Curve Characteristics



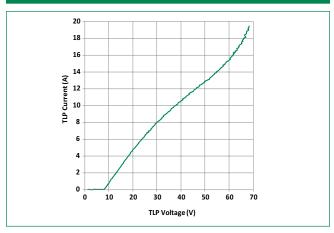
- ${f V_a}$ Stand-off Voltage Maximum voltage that can be applied to the TVS without operation
- ${f V_{BR}}$ **Breakdown Voltage** Maximum voltage that flows though the TVS at a specified test current (${f I_T}$)
- $m V_c$ Clamping Voltage Peak voltage measured across the TVS at a specified Ippm (peak impulse current)
- I_R Reverse Leakage Current Current measured at V_R
- $\mathbf{V}_{_{\mathrm{F}}}$ Forward Voltage Drop for Uni-directional



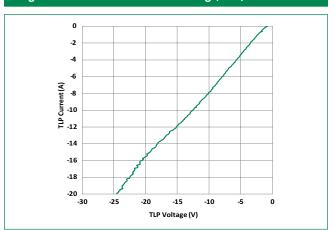




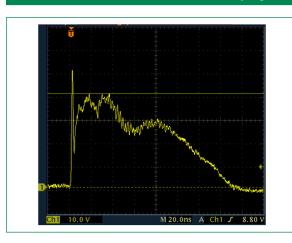




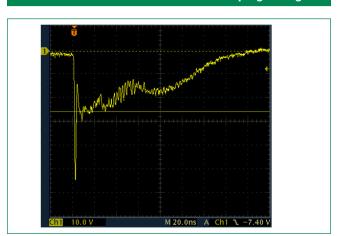
Negative Transmission Line Pulsing (TLP) Plot



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



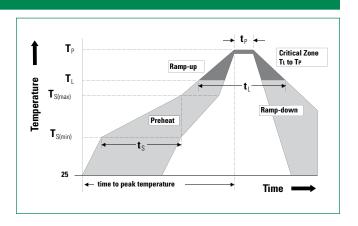
IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage





Soldering Parameters

Reflow Cond	Pb – Free assembly		
Pre Heat	-Temperature Min (T _{s(min)})	150°C	
	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ram	3°C/second max		
T _{S(max)} to T _L -	3°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		260 ^{+0/-5} °C	
Time within	Time within 5°C of actual peak Temperature (t _p)		
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _p)		8 minutes Max.	
Do not exceed		260°C	



Part Marking System

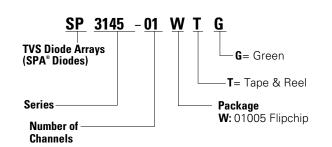


Ordering Information

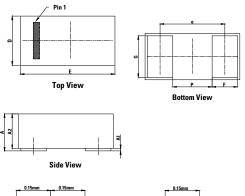
Recommended soldering pad layout

Part Number	Package	Min. Order Qty.		
SP3145-01WTG	01005 Flipchip	15000		

Part Numbering System



Package Dimensions — 01005 Flipchip

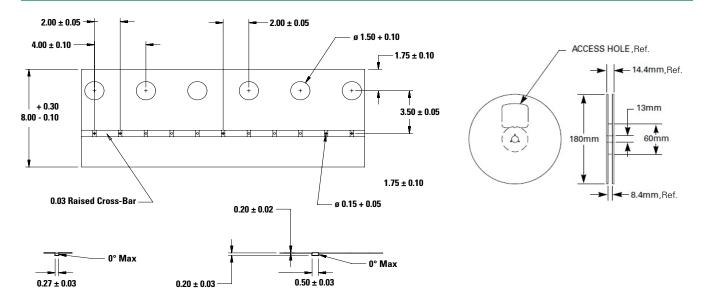


0.15mm
0.22mm
0.30mm
Stencil apertures

	01005 Flipchip					
Symbol	Millimeters		Inches			
	Min	Тур	Max	Min	Тур	Max
Α	0.168	0.181	0.194	0.007	0.007	0.008
A1	0.008	0.011	0.014	0.000	0.000	0.001
A2	0.160	0.170	0.180	0.006	0.007	0.007
е	0.280 BSC		0.011 BSC			
D	0.200	0.230	0.260	0.008	0.009	0.010
E	0.400	0.430	0.460	0.016	0.017	0.018
F	0.110	0.130	0.150	0.004	0.005	0.006
G	0.180	0.200	0.220	0.007	0.008	0.009
P	0.130	0.150	0.170	0.005	0.006	0.007



Embossed Carrier Tape & Reel Specification — 01005 Flipchip



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ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF
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VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF D1213A-01LP4-7B
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